

Weidmüller Interface GmbH & Co. KG Klingenbergstraße 26 D-32758 Detmold

Germany www.weidmueller.com

Product image





Similar to illustration

High-temperature-resistant male header, 3.50 mm pitch.

- Plugging direction parallel (90°), straight 180° or angled (135°) to PCB
- Housing variants: closed side (G), screw flange (F), solder flange (LF) or snap-on solder flange (RF)
- Optimised for the SMT process
- Pin length 3.2 mm universal for all soldering methods
- Pin length 1.5 mm optimised for reflow soldering methods
- Packed either in a box (BX) or tape-on-reel (RL)
- Male header can be coded

General ordering data

Version	PCB plug-in connector, male header, Flange, THT/ THR solder connection, 3.50 mm, Number of poles: 18, 180°, Solder pin length (I): 1.5 mm, tinned, black, Tape
Order No.	1896500000
Туре	SL-SMT 3.50/18/180F 1.5SN BK RL
GTIN (EAN)	4032248511303
Qty.	230 pc(s).
Product data	IEC: 320 V / 15 A UL: 300 V / 10 A
Packaging	Таре



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Technical data

Dimensions and weights

Depth	7.5 mm	Depth (inches)	0.295 inch
Height	12.6 mm	Height (inches)	0.496 inch
Height of lowest version	11.1 mm	Net weight	8.174 g
Width	70 mm	Width (inches)	2.756 inch

System specifications

Product family	OMNIMATE Signal - series BL/SL 3.50			
Type of connection	Board connection			
Mounting onto the PCB	THT/THR solder connection			
Pitch in mm (P)	3.5 mm			
Pitch in inches (P)	0.138 inch			
Outgoing elbow	180°			
Number of poles	18			
Number of solder pins per pole	1			
Solder pin length (I)	1.5 mm			
Solder pin length tolerance	0 / -0.3 mm			
Solder pin dimensions	d = 1.2 mm, Octagonal			
Solder pin dimensions = d tolerance	0 / -0,03 mm			
Solder eyelet hole diameter (D)	1.4 mm			
Solder eyelet hole diameter tolerance (D	0)+ 0,1 mm			
Outside diameter of solder pad	2.3 mm			
Template aperture diameter	2.1 mm			
L1 in mm	59.5 mm			
L1 in inches	2.343 inch			
Number of rows	1			
Pin series quantity	1			
Touch-safe protection acc. to DIN VDE 57 106	Safe from back-of-hand touch			
Touch-safe protection acc. to DIN VDE 0470	IP 10			
Volume resistance	≤5 mΩ			
Can be coded	Yes			
Tightening torque for screw flange, max	κ. 0.1 Nm			
Plugging force/pole, max.	6 N			
Pulling force/pole, max.	6 N			
Tightening torque	Torque type	Mounting screw, PCB		
	Usage information	Tightening torque	min.	0.1 Nm
			max.	0.15 Nm
		Recommended screw	Part	PTSC KA
			number	<u>2.2X4.5</u>
				<u>WN1412</u>

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	CuSn
Contact surface	tinned	Layer structure of solder connection	23 µm Ni / 57 µm Sn
Layer structure of plug contact	23 µm Ni / 57 µm Sn	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

Technical data



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200039-1176845

300 V

10 A

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Rated o	data	acc.	to	IEC
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tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	15 A
Rated current, max. number of poles		Rated current, min. number of poles	
(Tu=20°C)	12 A	(Tu=40°C)	13 A
Rated current, max. number of poles		Rated voltage for surge voltage class /	
(Tu=40°C)	10 A	pollution degree II/2	320 V
Rated voltage for surge voltage class /		Rated voltage for surge voltage class /	
pollution degree III/2	160 V	pollution degree III/3	160 V
Rated impulse voltage for surge voltage		Rated impulse voltage for surge voltage	
class/ pollution degree II/2	2.5 kV	class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage		Short-time withstand current resistance	
class/ contamination degree III/3	2.5 kV		3 x 1s with 100 A

Rated data acc. to CSA

Institute (CSA)	SP ¹	Certificate No. (CSA)
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)
Reference to approval values	Specifications are maximum values, details - see approval certificate.	

Rated data acc. to UL 1059

Institute (UR)



Rated voltage (Use group B / UL 1059)	300 V
Rated current (Use group B / UL 1059)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.

Certificate No. (UR)

	E60693
Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group D / UL 1059)	10 A

Packing

Packaging	Таре	VPE length	90 mm
VPE width	330 mm	VPE height	330 mm
Tape depth (T2)	16.5 mm	Tape width (W)	88 mm
Tape pocket depth (K0)	16 mm	Tape pocket height (A0)	7.8 mm
Tape pocket width (B0)	71.8 mm	Tape pocket separation (P1)	16 mm
Tape hole separation (E)	1.75 mm	Tape pocket separation (F)	42.2 mm
Tape reel diameter Ø (A)	330 mm	Surface resistance	$Rs = 10^9 - 10^{12} \Omega$
Width Pick & Place Pad (W _{PPP})	6.8 mm	Length Pick & Place Pad (LPPP)	12.65 mm
Diameter of the withdrawal surface	(ø	Protrusion 1 Pick & Place Pad (L _{01 (P}	лер))
D _{max})	5 mm		2.7 mm
Protrusion 2 Pick & Place Pad (P _{02 (F}	_{PPP)}) 2.5 mm		



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Technical data

ETIM 6.0	EC002637	ETIM 7.0	EC002637	
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02	
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01	
Important note				
IPC conformity	standards and norms ar	ts are developed, manufactured and delive d comply with the assured properties in t A-610 "Class 2". Further claims on the pro	he data sheet resp. fulfill decorative propertie	
Notes	 Gold-plated contact s 	urfaces on request		
	Rated current related	to rated cross-section & min. No. of poles.		
	Diameter of solder ey	elet D = 1.4+0.1mm		
	• Solder eyelet diameter D = 1.5 + 0.1 mm, from 9 poles			
	• P on drawing = pitch			
	 Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. 			
	 For additional mechanical support for male connectors with screw flange (F), we recommend an additional cable gland with fastening screws (sheet metal screw ISO 1481-ST 2.2x4.5 C or ISO 7049-ST 2.2x4.5 C – see Accessories). Cable gland only permitted before soldering. 			
	Long term storage of	the product with average temperature of	50 °C and average humidity 70%, 36 month	
Approvals				
Approvals		•		
		R		
ROHS	Conform			
JL File Number Search	E60693			
Downloads				
Engineering Data	<u>STEP</u>			

Drawings

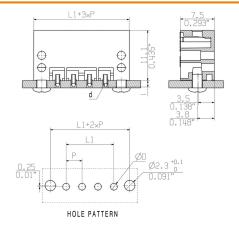


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Dimensional drawing

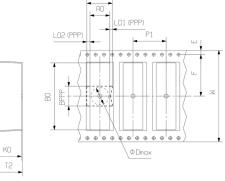


Dimensional drawing

Pl to.1



Dimensional drawing



DIRECTION OF UNREELING

Example of use



Wave Solder Profile

Recommended wave solderding profiles

Weidmüller 🟵

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Double Wave:

Single Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

Reflow Solder Profile

Recommended reflow soldering profile



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Time [sec]

Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.